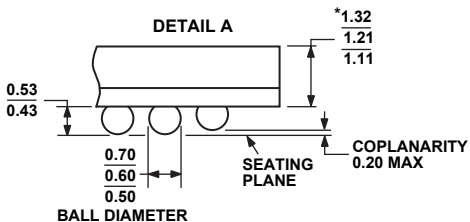
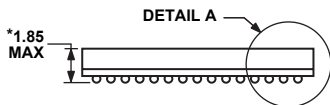
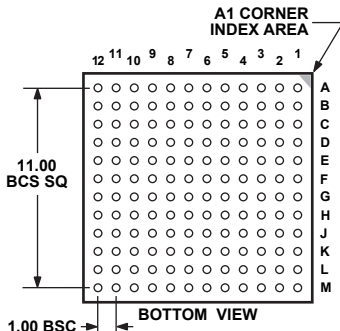
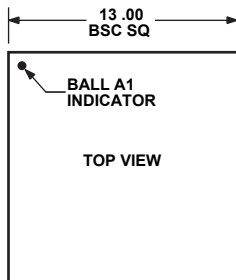


144-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]  
(BC-144-3)

Dimensions shown in millimeters



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\*COMPLIES WITH JEDEC STANDARD MO-99-A - WITH  
EXCEPTION TO PACKAGE HEIGHT AND THICKNESS.